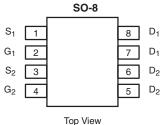


Vishay Siliconix

Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Typ.)		
- 20	0.058 at V _{GS} = - 4.5 V	- 4	8		
	0.094 at V_{GS} = - 2.5 V	- 4	0		



Ordering Information: Si9933CDY-T1-E3 (Lead (Pb)-free) Si9933CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

• Halogen-free Option Available

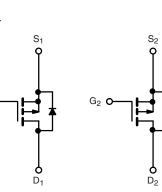
G1 0

- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

Load Switch

DC/DC Converter



P-Channel MOSFET

P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 20	v		
Gate-Source Voltage		V _{GS}	± 12	v	
	T _C = 25 °C		- 4 ^e		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		- 4 ^e		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		- 4 ^{b, c, e}		
	T _A = 70 °C		- 3.8 ^{b, c}	Α	
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	- 20	A	
Source-Drain Current Diode Current	T _C = 25 °C		- 2.5		
	T _A = 25 °C	I _S	- 1.7 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 6		
Single-Pulse Avalanche Energy		E _{AS}	1.8	mJ	
	T _C = 25 °C		3.1		
Maximum Power Dissipation	T _C = 70 °C	P _D	2	w	
	T _A = 25 °C	FD D	2 ^{b, c}	vv	
	T _A = 70 °C	1	1.28 ^{b, c}		
Operating Junction and Storage Temperature Rang	T _J , T _{stq}	- 50 to 150	°C		

THERMAL RESISTANCE RATINGS						
			Limit			
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	52	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	32	40	0/10	

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 110 °C/W.

e. Package Limited.





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SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = - 250 μ A	- 20			V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 19		mV/°C		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			3.1				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.6		- 1.4	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			- 100	nA		
Zero Gate Voltage Drain Current	1	$V_{DS} = -20 V, V_{GS} = 0 V$			- 1	— иА		
	IDSS	V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10			
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = \le -5 V$, $V_{GS} = -10 V$	- 20			Α		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 4.8 A		0.048	0.058	Ω		
		V _{GS} = - 2.5 V, I _D = - 1 A		0.075	0.094			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 10 V, I _D = - 4.8 A		11		S		
Dynamic ^a					•			
Input Capacitance	C _{iss}			665		pF		
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		140				
Reverse Transfer Capacitance	C _{rss}			115				
T + 10 + 0		V_{DS} = - 10 V, V_{GS} = - 10 V, I_{D} = - 4.8 A		17	26	nC		
Total Gate Charge	Q_g			8	12			
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.8 \text{ A}$		2				
Gate-Drain Charge	Q _{gd}			3				
Gate Resistance	R _a	f = 1 MHz	1.2	6	12	Ω		
Turn-On Delay Time	t _{d(on)}			6	12			
Rise Time	t _r	V_{DD} = - 10 V, R_{L} = 2.6 Ω		15	23	- ns		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 3.8 A, V_{GEN} = - 10 V, R_q = 1 Ω		26	39			
Fall Time	t _f			9	18			
Turn-On Delay Time	t _{d(on)}			21	32			
Rise Time	t _r	V_{DD} = - 10 V, R _L = 2.6 Ω		50	75			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 3.8 A, V_{GEN} = - 4.5 V, R_q = 1 Ω		29	44			
Fall Time	t _f			13	20			
Drain-Source Body Diode Characteris	tics					•		
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 2.5			
Pulse Diode Forward Current ^a	I _{SM}	-			- 20	A		
Body Diode Voltage	V _{SD}	I _S = - 3.8 A		- 0.77	- 1.2	V		
Body Diode Reverse Recovery Time	t _{rr}	$I_F = -3.8 \text{ A, dl/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 \text{ °C}$		30	45	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			17	26	nC		
Reverse Recovery Fall Time	t _a			16	-			
Reverse Recovery Rise Time	t _b	4		14		ns		

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

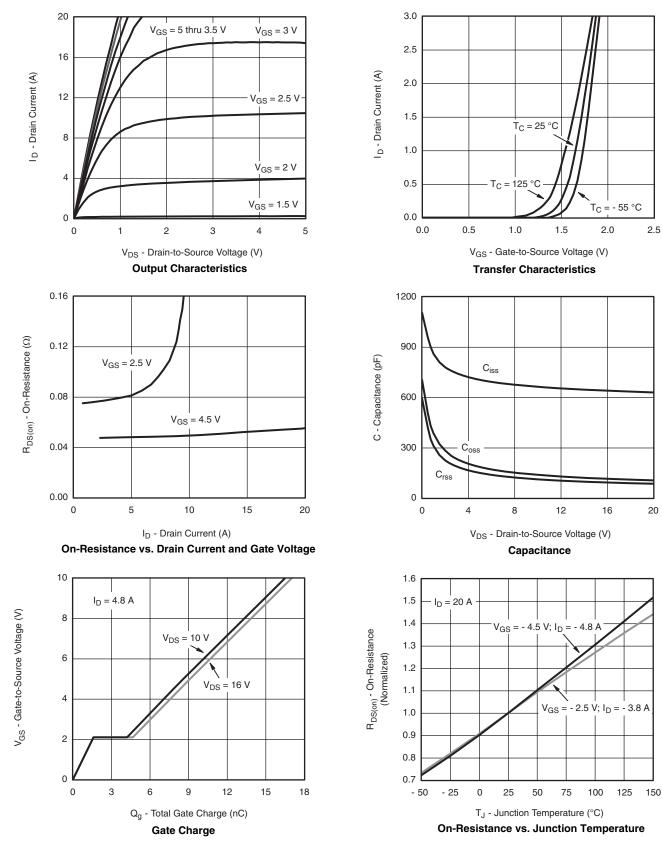
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





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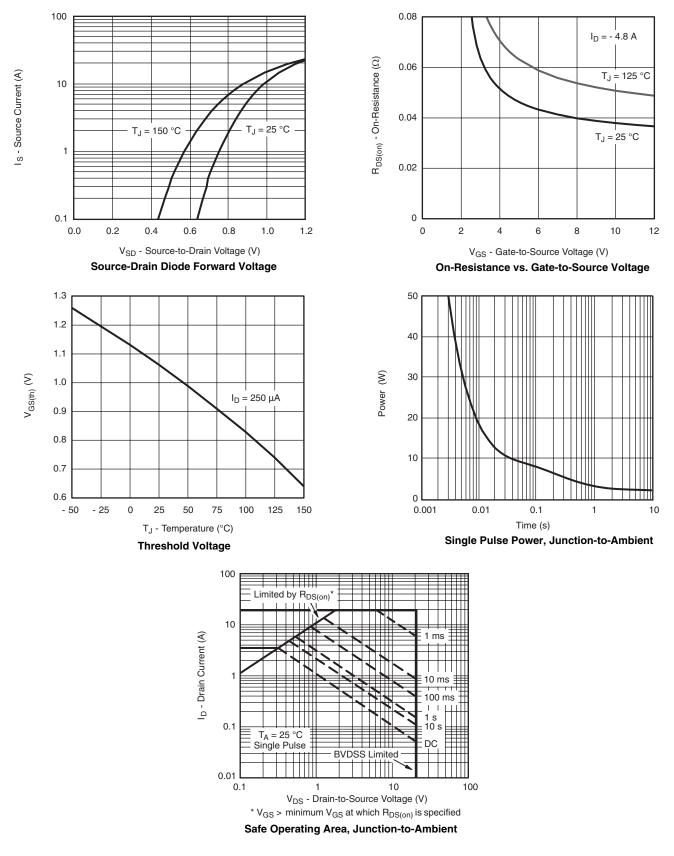


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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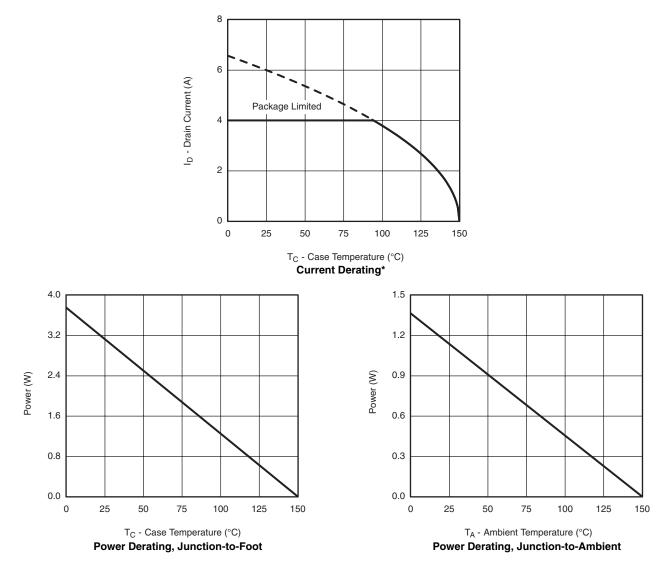
New Product



Si9933CDY

Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

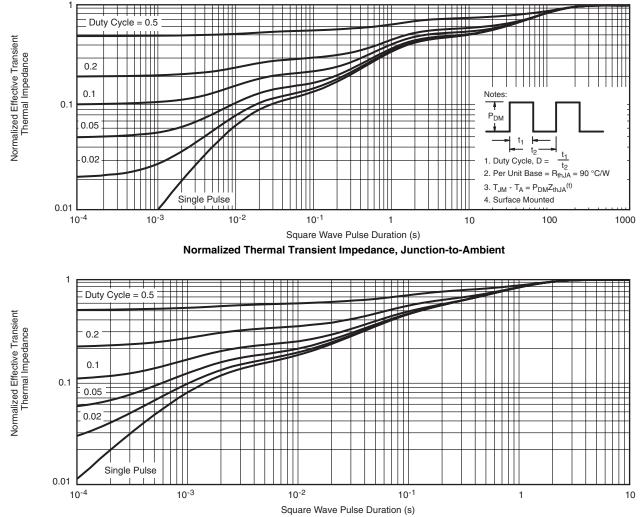


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68791.



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